

## India PCB Tech conference



“Importance of a robust supply chain and value addition to strengthen the PCB sector in India.”

The supporting program for productronica India 2019 will be finalized in summer 2019. In the meantime you may check the supporting program of productronica India 2018 below.

‘India PCB Tech’ is a joint initiative by ELCINA and Messe Muenchen India, and is supported by IPCA, to bring the entire PCB industry eco-system and related supply chain together. The policy makers, manufacturers as well as various stakeholders will exchange valuable information on market and technology trends, technical skills, policies, for enabling success and growth of PCB manufacturing and assembly sector. It will also showcase the PCB technologies from the best manufacturers and their suppliers from across the globe.

<b>Date:</b>	September 27, 2018
<b>Time:</b>	13:30–17:00
<b>Venue:</b>	Cassia hall, Conference Center, BIEC, Bengaluru
<b>Organized by:</b>	ELCINA and Messe Muenchen India
<b>Supported by:</b>	IPCA

## SAVE THE DATE

**productronica India | International Trade Fair for Electronics Development and Production**

Date: Sep 25 - 27, 2019

## Your contact

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## Organizer and Supporter



Organizer



Supporter

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### Agenda

<b>Theme:</b>	“Importance of a robust supply chain and value addition to strengthen the PCB sector in India.”
13:00–14:00	Networking lunch “CEO forum”
13:30–14:00	Registration
14:00–15:00	<b>Trends in the Indian market and growth opportunities</b>
14:00–15:00	<b>Global markets and trends in printed circuit technology</b> <ul style="list-style-type: none"><li>• Design for Excellence on High density Assemblies</li></ul> <p>Mr. Jonas Sjoberg, Technical Manager, Indium Corporation</p> <ul style="list-style-type: none"><li>• Mr. Richard Chu, Consultant, TPCA</li><li>• Mr. Wonki Nam, KPCA</li><li>• Mr. David W. Bergman, IPC</li><li>• <b>The role of simulation in innovative circuit board design</b></li></ul> <p>Mr. O.J. Satish, CEO, Siena ECAD</p> <ul style="list-style-type: none"><li>• <b>Technology Trend: Driving convergence of PCB</b></li></ul>

	<p><b>technology across market segments</b></p> <p>Mr. Rajkumar, Sr. Vice President, TTM Technologies</p>
16:00–17:00	<p><b>PCB supply chain in India —Need for Integrating with Global Industry</b></p> <ul style="list-style-type: none"><li>• Mr. Richard Puthota, ELCINA EC Member &amp; Sr. Director, Alpha Assembly Solutions</li><li>• Mr. Amulya Mohapatra, HOD, Production, AT&amp;S India</li><li>• <b>RF applications and heat management</b></li></ul> <p>Mr. Yaad Eliya—CTO, R&amp;D and Technology Manager, PCB Technologies Ltd.</p>

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